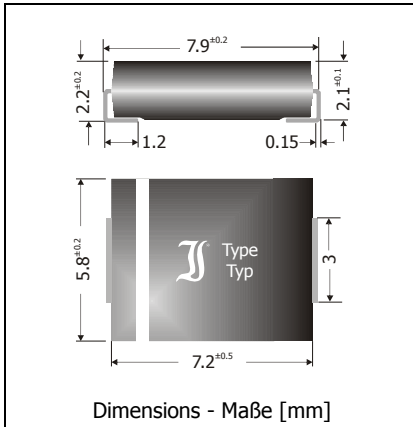


## SK52SMC ... SK510SMC

### Surface Mount Schottky Rectifiers Schottky-Gleichrichter für die Oberflächenmontage

Version 2014-01-21



Nominal current – Nennstrom

5 A

Repetitive peak reverse voltage  
Periodische Spitzensperrspannung

20...100 V

Plastic case  
Kunststoffgehäuse~ SMC  
~ DO-214AB

Weight approx. – Gewicht ca.

0.21 g

Plastic material has UL classification 94V-0  
Gehäusematerial UL94V-0 klassifiziertStandard packaging taped and reeled  
Standard Lieferform gegurtet auf Rolle

### Maximum ratings

### Grenzwerte

Type Typ <sup>1)</sup>	Repetitive peak reverse voltage Periodische Spitzensperrspannung $V_{RRM}$ [V]	Surge peak reverse voltage Stoßspitzensperrspannung $V_{RSM}$ [V]	Forward voltage Durchlass-Spannung $V_F$ [V] <sup>2)</sup>
SK52SMC	20	20	< 0.55
SK53SMC	30	30	< 0.55
SK54SMC	40	40	< 0.55
SK55SMC	50	50	< 0.68
SK56SMC	60	60	< 0.68
SK58SMC	80	80	< 0.83
SK510SMC	100	100	< 0.83

Max. average forward rectified current, R-load  
Dauergrenzstrom in Einwegschaltung mit R-Last $T_T = 100^\circ\text{C}$  $I_{FAV}$ 5 A<sup>3)</sup> $T_T = 85^\circ\text{C}$  $I_{FAV}$ 5 A<sup>4)</sup>Repetitive peak forward current  
Periodischer Spitzenstrom $f > 15$  Hz $I_{FRM}$ 

20 A

 $T_T = 85^\circ\text{C}$ Peak forward surge current, 50/60 Hz half sine-wave  
Stoßstrom für eine 50/60 Hz Sinus-Halbwellen $T_A = 25^\circ\text{C}$  $I_{FSM}$ 

100/110 A

Rating for fusing,  $t < 10$  ms  
Grenzlastintegral,  $t < 10$  ms $T_A = 25^\circ\text{C}$  $i^2t$ 50 A<sup>2</sup>sOperating junction temperature – Sperrschichttemperatur  
Storage temperature – Lagerungstemperatur $T_j$ 

-50...+150°C

 $T_s$ 

-50...+150°C

1 Currently available: SK55SMC, SK56SMC – Momentan erhältlich: SK55SMC, SK56SMC

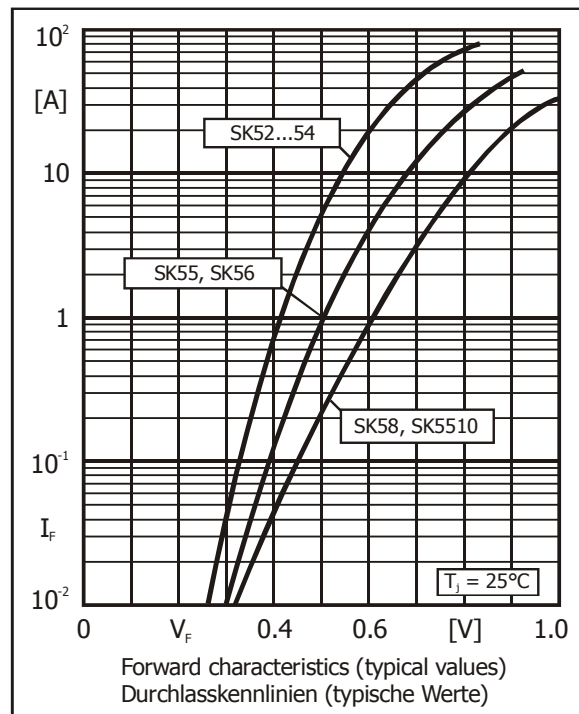
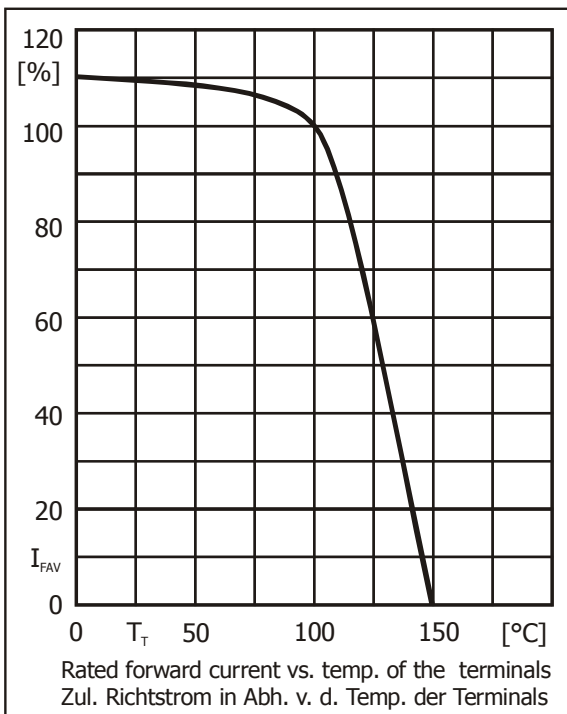
2  $I_F = 5$  A,  $T_j = 25^\circ\text{C}$ 

3 SK52SMC ... SK56SMC

4 SK58SMC, SK510SMC

**Characteristics**
**Kennwerte**

Leakage current Sperrstrom	$T_j = 25^\circ\text{C}$ $T_j = 100^\circ\text{C}$	$V_R = V_{RRM}$ $V_R = V_{RRM}$	$I_R$ $I_R$	$< 150 \mu\text{A}$ $< 20 \text{ mA}$
Thermal resistance junction to ambient air Wärmewiderstand Sperrschicht – umgebende Luft			$R_{thA}$	$< 45 \text{ K/W}^1)$
Thermal resistance junction to terminal Wärmewiderstand Sperrschicht – Anschluss			$R_{thT}$	$< 10 \text{ K/W}$



1 Mounted on P.C. board with 50 mm<sup>2</sup> copper pads at each terminal  
Montage auf Leiterplatte mit 50 mm<sup>2</sup> Kupferbelag (Lötpad) an jedem Anschluss